POLITECNICO DI TORINO Repository ISTITUZIONALE

Development of an automated SILAR method for the sustainable fabrication of BiOI/TiO photoanodes

Original

Development of an automated SILAR method for the sustainable fabrication of BiOI/TiO photoanodes / Altieri, Roberto; Schmitz, Fabian; Schenker, Manuel; Boll, Felix; Rebecchi, Luca; Schweitzer, Pascal; Crisci, Matteo; Kriegel, Ilka; Smarsly, Bernd; Schlettwein, Derck; Lamberti, Francesco; Gatti, Teresa; Wang, Mengjiao. - In: ENERGY ADVANCES. - ISSN 2753-1457. - (2024). [10.1039/d4ya00405a]

Availability: This version is available at: 11583/2992280 since: 2024-09-06T12:12:16Z

Publisher: Royal Society of Chemistry

Published DOI:10.1039/d4ya00405a

Terms of use:

This article is made available under terms and conditions as specified in the corresponding bibliographic description in the repository

Publisher copyright

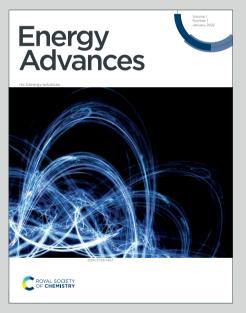
(Article begins on next page)

Energy Advances

View Article Online _{View Journal}

Accepted Manuscript

This article can be cited before page numbers have been issued, to do this please use: R. Altieri, F. Schmitz, M. Schenker, F. Boll, L. Rebecchi, P. Schweitzer, M. Crisci, I. Kriegel, B. Smarsly, D. Schlettwein, F. Lamberti, T. Gatti and M. Wang, *Energy Adv.*, 2024, DOI: 10.1039/D4YA00405A.



This is an Accepted Manuscript, which has been through the Royal Society of Chemistry peer review process and has been accepted for publication.

Accepted Manuscripts are published online shortly after acceptance, before technical editing, formatting and proof reading. Using this free service, authors can make their results available to the community, in citable form, before we publish the edited article. We will replace this Accepted Manuscript with the edited and formatted Advance Article as soon as it is available.

You can find more information about Accepted Manuscripts in the Information for Authors.

Please note that technical editing may introduce minor changes to the text and/or graphics, which may alter content. The journal's standard <u>Terms & Conditions</u> and the <u>Ethical guidelines</u> still apply. In no event shall the Royal Society of Chemistry be held responsible for any errors or omissions in this Accepted Manuscript or any consequences arising from the use of any information it contains.



rsc.li/energy-advances

Open Access Article. Published on 05 September 2024. Downloaded on 9/6/2024 1:59:51 PM

Development of an automated SILAR method for the sustainable fabrication of BiOI/TiO₂ photoanodes

Roberto Altieri^{a,b}, Fabian Schmitz^{a,b}, Manuel Schenker^{a,b}, Felix Boll^{a,b}, Luca Rebecchi^c, Pascal Schweitzer^{a,d}, Matteo Crisci^{a,b}, Ilka Kriegel^c, Bernd Smarsly^{a,b}, Derck Schlettwein^{a,d}, Francesco Lamberti^e, Teresa Gatti^{a,f*} and Mengjiao Wang^{f*}

^a Center for Materials Research, Justus Liebig University, Heinrich-Buff-Ring 17, 35392 Giessen, Germany

^e Department of Chemical Sciences, University of Padova, via Marzolo 1, 35131 Padova, Italy

Abstract: BiOl is a promising material for use in photoelectrocatalytic water oxidation, renowned for its chemical inertness and safety in aqueous media. For device integration, BiOl must be fabricated into films. Considering future industrial applications, automated production is essential. However, current BiOl film production methods lack automation and efficiency. To address this, a continuous automated process is introduced in this study, named AutoDrop, for producing BiOl films. Autodrop results to be a fast and facile method for producing BiOl photoelectrodes. Nanostructured thin films of this layered material are prepared using a syringe pump to dispense the precursor solution onto a continuously spinning substrate. These films are integrated into a multilayered photoelectrode, featuring mesoporous TiO₂ as an electron-transporting layer on top of FTO glass. In testing the photoelectrochemical performance of the BiOl/TiO₂ photoelectrodes, the highest photocurrent (44 μ A/cm²) is found for a heterojunction with a BiOl thickness of 320 nm. Additionally, a further protective TiO₂ ultrathin layer in contact with BiOl, grown by atomic layer deposition, enhances the durability and efficiency of the photoanode, resulting in more than a two-fold improvement in photocurrent after 2 hours of continuous operation. This study advances the automation in the sustainable production of photoelectrode films and provides inspiration for further developments in the field.

Keywords. Bismuth oxyiodide, photoanode, automated SILAR, autodrop, solution processing

1. Introduction

The use of semiconductor-based devices in photoelectrochemical (PEC) processes with a small Carbon footprint offers a sustainable approach to address critical environmental challenges, particularly in hydrogen production through water splitting.^{1,2} PEC represents a promising technique that combines light absorption and electrocatalysis within a single device.³ However, photoelectrodes must be designed to overcome challenges such as chemical instability, electrolyte resistance, and mass transfer issues.⁴ The slow production at the laboratory scale and the difficulty in controlling the quality of photoactive material films significantly hinder their application and industrialization.⁵ Consequently, research efforts are needed to develop methods for producing photoactive materials with enhanced efficiency and improved quality control.

Bismuth oxyhalides (BiOX, where X = Cl, Br, I) have garnered significant interest in photoelectrocatalysis due to their chemical stability under bias, favorable band gaps, and distinctive layered crystal structure, which provides a high surface area and potential active sites for catalytic reactions.⁶ They are based on bismuth, an a-toxic and non-critical element, which makes them even more appealing for technical applications.⁷ Among oxyhalides, BiOI exhibits the

^b Institute of Physical Chemistry, Justus Liebig University, Heinrich-Buff-Ring 17, 35392 Giessen, Germany

^c Functional Nanosystems, Istituto Italiano di Tecnologia, via Morego 30, 16163 Genova, Italy

^d Institute of Applied Physics, Justus Liebig University, Heinrich-Buff-Ring 16, 35392 Giessen, Germany

^f Department of Applied Science and Technology, Politecnico di Torino, Corso Duca degli Abruzzi 24, 10129 Torino, Italy.

^{*} E-mail: teresa.gatti@polito.it ; mengjiao.wang@polito.it

nergy Advances Accepted Manuscript

widest absorption in the visible light spectrum due to its small band gap, ranging from 1.8 eV to 2.3 eV, making it suitable for solar-driven photoelectrocatalytic applications.⁸ Based on its semiconducting character, BiOI encompasses its role in PEC water oxidation⁹, dye degradation¹⁰ and the reduction of N₂.¹¹ However, applying BiOI in photoelectrocatalysis typically involves producing BiOI films by methods such as filtration¹², solvothermal¹³, drop casting¹⁴, electrodeposition¹⁵, or chemical bath deposition¹⁶. These techniques often result in films with inconsistent quality and performance and are not suitable for large-scale production and automation. Successive ionic layer adsorption and reaction (SILAR) is a low-cost, low energy consumption, and simple approach typically carried out by dip coating, where the substrate is rinsed in precursor solutions, with washing steps in between each cycle.¹⁷ However, achieving film homogeneity is challenging due to the multiple rinsing steps.¹⁸ To expedite the procedure and enhance reproducibility, BiOI thin films have been prepared using a spin coater (spin-SILAR).¹⁹ Instead of typical dipping cycles, controlling the amounts of precursor solutions becomes a key parameter in defining the thickness and quality of the films through spincoating. However, further improvements are necessary to fully achieve automation in SILAR-like processes.

For integrating BiOI into PEC devices, it is important to improve the electronic properties of the material and adjust its processing. In previous work, pure BiOI has exhibited relatively low charge carrier mobility, hindering efficient transport of charge carriers and leading to a reduced PEC activity.²⁰ Additionally, BiOI is prone to rapid recombination of photogenerated electron-hole pairs, further diminishing its efficiency in PEC processes.²¹ Therefore, BiOI is typically combined with other semiconductors to enhance charge transfer and mitigate recombination, with TiO₂ being reported as a suitable component for improving its PEC properties.^{22–24} For instance, a BiOI/TiO₂ heterostructure has been shown to be more photoactive than its individual components in the degradation of methyl orange.²⁵ The formation of the heterojunction improves the transfer of photoinduced electrons from BiOI to TiO₂, reducing charge recombination by forming a p-n junction. Combinations of BiOI and TiO₂ nanorods or nanosheets have been reported for PEC water oxidation and organics degradation, demonstrating enhanced PEC activity of BiOI/TiO₂ compared to just BiOI and thus showing the value of such binary heterojunctions based on a-toxic materials for future industrial applications.^{26–28}

Apart from PEC efficiency, ensuring the stability of the photoelectrode is crucial. To enhance photoelectrode stability for water splitting, TiO₂ and Al₂O₃ surface protection layers are commonly applied to prevent catalyst corrosion.²⁹ Moehl et al. found that 30 nm amorphous TiO₂ layers on top of fluorine-doped tin oxide (FTO) stabilize the photocurrent.³⁰ By coating ZnO/Si photoelectrodes with an ultra-thin atomic layer deposited (ALD) TiO₂, Kargar et al. significantly improved the stability from 60 to 100 minutes of continuous operation.³¹ Choi et al. have demonstrated that a thin layer of Al₂O₃ on Si can effectively prevent oxidation of Si and reduce the overpotential by providing surface passivation.³² Similarly, various studies have highlighted the benefits of applying TiO₂ and Al₂O₃ protective layers on photoelectrodes like Cu₂O, Si, Cu₂ZnSnS₄, and InP, showing that these layers serve as effective tools to enhance the operational stability of both photoanodes and photocathodes.³³

Inspired by the recent advancements in BiOI film-production techniques and the verified PEC properties of BiOI/TiO₂ heterojunctions, we present a modified spin-SILAR method, to render it less time-consuming and more automated. In this work, we propose the use of a syringe pump coupled with a spin coater to deliver Bi and I precursors with precise stoichiometry on substrates, as sketched in Figure 1. This process, that we have named "Autodrop", offers several advantages over standard SILAR and spin-SILAR methods. By continuously dropping the solutions onto the film instead of using discrete, repetitive cycles, this technique enhances the uniformity and consistency of the deposited layers while accelerating the overall process. Additionally, controlling the flow rates of the solutions allows for improved

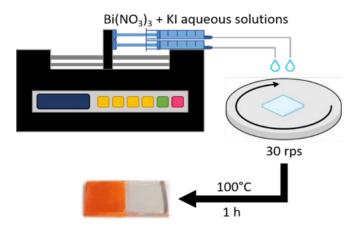
Open Access Article. Published on 05 September 2024. Downloaded on 9/6/2024 1:59:51 PM

stoichiometry in the deposited films. Using this method, we produced BiOI thin films on mesoporous TiO₂-coated FTO. The mesoporous TiO₂ plays an important role in forming uniform BiOI layers and allows to build type-II heterojunctions. We systematically investigate the effect of film thickness on the band alignment and the performance of the resulting heterojunctions in PEC water oxidation. When BiOI has a thickness of 320 nm, the BiOI/TiO₂ heterojunction shows an optimized photocurrent. Additionally, an ultra-thin TiO₂ film deposited by atomic layer deposition (ALD) on top of the BiOI/TiO₂ heterojunction further improves PEC properties and stability. This study demonstrates the potential for boosting automation in BiOI film production, achieving active layers of comparable quality to those produced manually but in significantly less time. Furthermore, it shows that detailed control over the band gap and thickness of the BiOI films can be achieved with such an automated process. The AutoDrop method has the potential to be further extended to the production of films of other materials typically synthesized via SILAR, advancing sustainable solution-processing towards greater automation and reproducibility.

Figure 1. Schematic representation of the AutoDrop process developed in this work and used to produce BiOI thin films.

2. Results and discussion

BiOI films were prepared either on pure FTO, FTO covered by a compact layer of TiO₂ (FTO-planar TiO₂), or FTO covered



by a mesoporous layer of TiO₂ (FTO-mesoporous TiO₂) using the AutoDrop procedure to compare the uniformity of the achieved films (see Experimental Section for practical details). As shown in Figure 2, after applying the same amounts of precursors, the distribution of BiOI nanoflakes on bare FTO and mesoporous TiO₂ substrates results in uniform films, while on planar TiO₂, the BiOI film is less uniform, as observed in top-view scanning electron microscopy (SEM) images. Optical images of the three produced thin films also reveal a homogeneous color distribution across BiOI films on FTO and mesoporous TiO₂ substrates. In contrast, the faded yellow color observed on planar TiO₂ indicates a significant loss of precursor during the AutoDrop synthesis. This discrepancy in BiOI film quality is attributed to the different topologies of the substrates: as shown in Figure S1 in the Supporting Information (S.I.), FTO and mesoporous TiO₂ feature larger grains and roughness compared to more planar compact TiO₂, suggesting that a rough surface facilitates the nucleation of BiOI microplatelets during the continuous SILAR process.

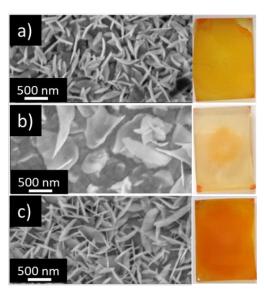


Figure 2. SEM images (left) and respective macroscopic photos (right) of large area BiOI thin films ($1x2 \text{ cm}^2$) prepared by the Autodrop method on top of a) FTO glass, b) FTO-planar TiO₂, c) FTO-mesoporous TiO₂.

In a further comparative study, a sample was prepared using a method similar to that employed by Putri et al., which involved manual spin-coating (spin-SILAR) of the precursors for up to 45 cycles (labelled as T/BiOI 45).¹⁹ As shown in Figure S2, the film produced with the AutoDrop technique exhibits superior spatial uniformity. The continuous spinning and dropping process helps avoid border inhomogeneity, likely due to a reduced surface tension.³⁴ Additionally, BiOI growth in the sample T/BiOI 1.2 (indicating the mesoporous BiOI/TiO₂ heterojunction produced by deposition of 1.2 mL of precursors, *vide infra*) forms in 16 minutes with the AutoDrop method, whereas more than 30 minutes are needed to produce T/BiOI 1.2 (Figure S2c), suggesting that the samples produced with the AutoDrop method have similar optical properties to those produced with the traditional manual spin-SILAR.

The impact of varying amounts of BiOI on the mesoporous TiO₂ substrates was investigated. Using the AutoDrop process, we adjusted the drop volume of precursor solutions while maintaining a constant injection rate of 75 μ L/min to control the BiOI film thickness. The BiOI/TiO₂ heterojunction films, with varying BiOI layer thicknesses, are labelled based on the drop volume of the KI solution used, with the volume of Bi(NO₃)₃ solution always equal to that of the KI solution, due to stoichiometric considerations. The samples are named as T/BiOI 0.4, T/BiOI 0.8, T/BiOI 1.2, and T/BiOI 1.6, corresponding to 0.4 mL, 0.8 mL, 1.2 mL, and 1.6 mL of the precursors, respectively, for the sake of clarity. The morphologies of the T/BiOI films for different BiOI precursor amounts (SEM top and side views) are shown in Figure 3. All the BiOI films show a uniform distribution of BiOI vertical nanoflakes with different orientations on the microscale (Figure 3a-d). The film prepared with the lowest BiOI precursor content (0.4 mL of KI and Bi(NO₃)₃, respectively) shows a less compact morphology compared to the other samples, as part of the mesoporous TiO₂ is still visible in Figure 3a in between the emerging BiOI nanoflakes. From the cross-sectional SEM images, shown in Figure 3e-h, the analysis of the BiOI film thickness indicates an expected increase from ≈180 nm to ≈450 nm when the dropping volume increases from 0.4 mL to 1.6 mL.

By analysis of the relationship between the drop volume and film thickness, we hypothesize that KI and $Bi(NO_3)_3$ are first used to form BiOI nanoflakes with a dimension of around 200 nm until the substrate has no more space to host

Open Access Article. Published on 05 September 2024. Downloaded on 9/6/2024 1:59:51 PM

BiOI nanoflakes. When the drop volume of KI or Bi(NO₃)₃ reaches 0.8 mL, there is no space to form new BiOI nanoflakes, and the precursor solutions are applied to enlarge the size of the previously formed seed-flakes in a hierarchical fashion. The thickness growth rate is roughly 312.5 nm/mL after the drop volume exceeds 0.8 mL (Figure S3). Given that the dropping speed of both precursors is 75 μ L/min and the general loss of precursor during spin-SILAR is approximately 95%, we estimate that the AutoDrop method forms about 8.26 BiOI atomic layers per minute (see S.I. for the calculations applied to estimate this number). Since the BiOI layers are randomly oriented on the substrate, the actual thickness of the BiOI layer is always greater than the theoretical thickness (Figure S3b).

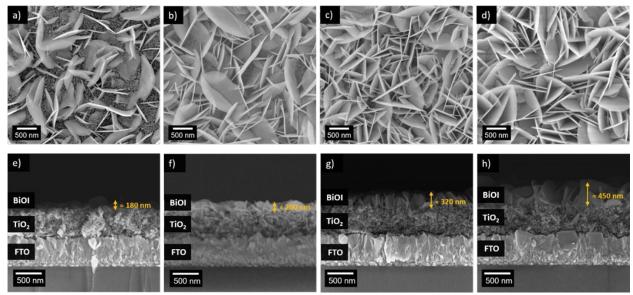


Figure 3. SEM images of T/BiOI films obtained by Autodrop with different dropping volumes in top-view and cross-section: a) and e) T/BiOI 0.4; b) and f) T/BiOI 0.8; c) and g) T/BiOI 1.2; d) and h) T/BiOI 1.6.

The structure of the thin films was examined using grazing incidence X-ray diffraction (GIXRD) analysis. The diffractograms reveal the absence of any side phases, showing reflections solely from BiOI and TiO₂ (Figure 4a). Notably, T/BiOI 0.4 exhibits more intense TiO₂ reflections compared to the other samples, suggesting greater exposure of TiO₂ within T/BiOI 0.4. Additionally, the (001) signal of BiOI at $\approx 10^{\circ}$ diminishes as the BiOI thickness increases. This decrease is likely due to the initial random orientation of BiOI nanoplates, which then tend to align vertically along the [001] direction on the TiO₂ substrate, thereby decreasing the intensity of the (001) signal. It is also noteworthy to observe the relative changes in BiOI characteristic reflections at 29.6° and 31.7°, as shown in Figure 4b. As the amount of BiOI increases, the intensity of the (110) signal becomes more pronounced compared to the (012) signal. This change can be attributed to a preferential growth along the (110) direction with the increasing amount of BiOI on the film. The XRD patterns obtained with different orientations of the samples corroborate this observation (see Figure S4). This vertical orientation of the flakes with respect to the FTO/TiO₂ electron-selective contact is promising to improve charge extraction across the pnictogen oxyhalide layer.

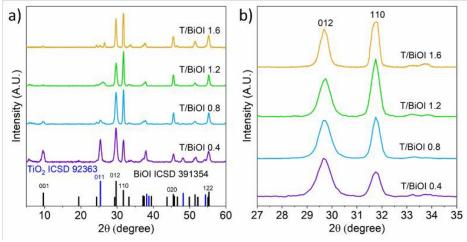


Figure 4. a) GIXRD patterns of T/BiOI samples with references of anatase TiO_2 and BiOI from the database; b) magnification of a) in the range of 27-35° highlighting the progressive increase in intensity of the (110) reflection in comparison with the (012) one.

DRS analysis is illustrated in Figure 5a. T/BiOI 0.4 exhibits absorption (here derived as a function of the measured reflectance obtained by applying the Kubelka-Munk transform) in the range of 300–550 nm. When the amount of BiOI is increased to 1.6 mL, the absorption range expands to 300–630 nm, and the overall absorption gradually intensifies. At a volume of 1.2 mL, the absorption reaches its peak, more than doubling compared to the T/BiOI 0.4 sample. However, further increasing the volume beyond 1.2 mL does not lead to additional improvement in absorption. The band-gap energy (E_g) was then calculated using the following equation (1):

$$\alpha h v = A (vh - E_g)^{n/2}$$

where α is the absorption coefficient of the material, h is Planck's constant, v is the incident light frequency, A is a constant, and n is the type of optical transition. For BiOI, being an indirect band-gap semiconductor, n equals 1. Based on DRS results, the calculated E_g of the samples ranged from 2.2 eV to 2.0 eV (see Figure 5b for Tauc plots and Table 1 for extrapolated values). Specifically, the band gap decreases with increasing film thickness. The varying sizes of BiOI nanoplatelets could explain this phenomenon, as larger sizes are associated with thicker nanoplatelets, which in turn alter E_g (Figure 3).¹⁹ However, it appears that the bandgap value for the thickest film tends to a plateau at approximately 2.0 eV, aligning with bandgap values reported for BiOI films in other studies.^{35,36} Furthermore, by adjusting the precursor volume in 0.2 mL intervals, a quasi-linear relationship is observed between the bandgap and the volume change up to 1.2 mL. Beyond 1.2 mL, the bandgap remains approximately constant at around 2 eV (Figure 5c). This demonstrates that, in conjunction with the conventional SILAR method, the AutoDrop process offers the potential for even finer bandgap tuning by allowing more precise control over the total volume dispensed.

(1)

Energy Advances Accepted Manuscript

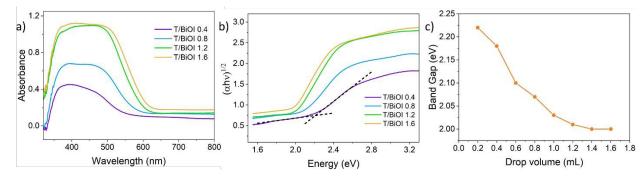


Figure 5. a) UV–vis DRS and b) Tauc plots of the T/BiOI samples prepared by Autodrop. c) Relationship between T/BiOI films band-gaps and the drop volume of the precursor solutions.

Table 1. E_g values of different thickness BiOI thin films grown via Autodrop on mesoporo	us TiO ₂ .

Precursor	E _g (eV)
volume	
(mL)	
0.4	2.18
0.8	2.07
1.2	2.01
1.6	2.00

The alignment of energy levels in the T/BiOI films was further characterized using a set of physical techniques. Figures 6a and 6c show the contact potential difference (CPD) map of typical BiOI and TiO₂ films obtained through Kelvin-probe force microscopy (KPFM) measurements. Since the work function (W_f) of the samples can be estimated from the fluctuation of CPD values, we find that the W_f values of BiOI and mesoporous TiO₂ are 4.33 eV and 4.10 eV, respectively (Figures 6b and 6d). XPS measurements in the range of the valence band maximum (VBM) also allows us to determine the difference between the Fermi level (E_f) and the VBM in the two samples (Figures 6e-f). The band gap was obtained from the Tauc plots (see Figure 5b). With this information, we can draw the energy diagram for BiOI before and after contacting TiO₂, as shown in Figure 6h. The diagrams reveal a decrease in the W_f (and therefore an increase in E_f) when BiOI is in contact with TiO₂, indicating the formation of a type-II heterojunction in BiOI/TiO₂. The higher conduction band minimum (CBM) of BiOI allows the injection of photogenerated electrons from BiOI to TiO₂, while the photogenerated holes in TiO₂ transfer and accumulate in BiOI to be exploited for further oxidation reactions. The band alignment of other T/BiOI samples were determined based on the Tauc plot in Figure 5b, the W_f of BiOI in Figure 6b, and the XPS spectra in Figure S5. Although the AutoDrop process achieves fine-tuning of the band structure of the BiOI films, the band positions and band gaps of other T/BiOI samples still form type-II heterojunctions with TiO₂ (Figure 6i).

Energy Advances Accepted Manuscrii

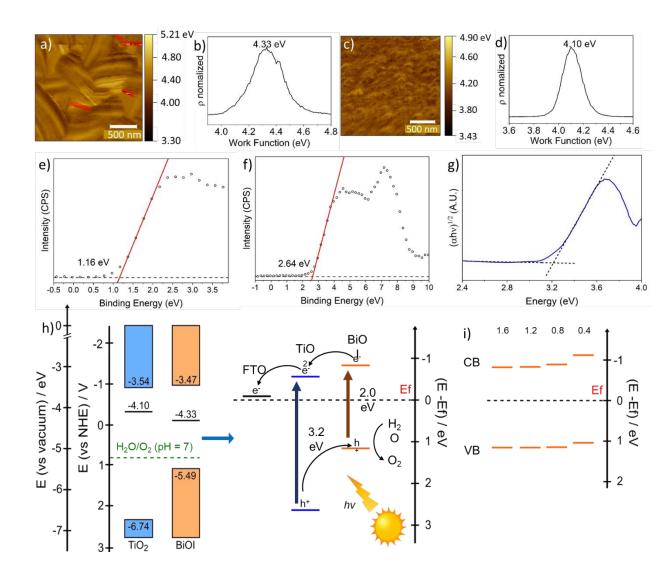


Figure 6. KPFM measurement image of a) BiOI and c) TiO_2 , respectively. W_f of b) T/BiOI 1.2 (on top of mesoporous TiO_2) and d) mesoporous TiO_2 thin films, respectively. In Figure b) only the marked regions were evaluated to avoid an influence of artifacts due to the steps across platelets. XPS spectra of e) T/BiOI 1.2 and f) mesoporous TiO_2 in the region of the VBM. The binding energy scale is reported with respect to E_F . The VBM occurs at the intersection of a line fit to the linear portion of the leading edge and the extended background line between the valence band maximum and E_F . g) Tauc plot of mesoporous TiO_2 thin film on FTO. h) Schematic diagram of energy level alignment, and the charge separation happening within the BiOI/TiO₂ heterojunction under solar light illumination; i) positions of band edges of BiOI films made with different drop volumes. Other XPS spectra are shown in Figure S5 and E_g values in Figure 4b and Table 1.

Based on this detailed analysis, the position of the VBM of BiOI in the heterojunction lies in a region favourable for the oxygen evolution reaction (OER) (Figure 6h). Thus, the PEC performance of the photoelectrodes was subsequently evaluated using a three-electrode system in a buffered phosphate solution at pH 7 under solar-simulated illumination. The linear sweep voltammetry (LSV) curves of all the T/BiOI samples are shown in Figure 7a. All photoelectrodes displayed negligible dark current density from 0.2 to 1.8 V vs the reversible hydrogen electrode (RHE). The photocurrent

density of T/BiOI 0.4, T/BiOI 0.8, T/BiOI 1.2, and T/BiOI 1.6 was 26, 33, 44, and 38 µA/cm² at 1.23 V versus RHE, respectively. The photocurrent density of the T/BiOI samples showed a significant increase compared to bare TiO₂. The photocurrent of T/BiOI 1.2 was about twice as high as that of bare mesoporous TiO₂. This enhancement in photocurrent can be attributed to the efficient separation and transfer of electrons and holes by the type-II heterojunction and large interface area between BiOI and TiO₂, in addition to better harvesting of visible photons in this binary system. The decrease in photocurrent in T/BiOI 1.6 may be due to the BiOI layer being too thick and extending beyond the depletion region of the BiOI/TiO₂ junction.²⁴ The LSV comparison of T/BiOI 45 with T/BiOI 1.2 in Figure S6 demonstrates the superior performance of T/BiOI 1.2, indicating that the AutoDrop method yields higher-quality films, resulting in better PEC performance. This enhancement is likely due to the closer connection between the TiO2 layer and the BiOI film created using the traditional SILAR method.

The transient photocurrent curves of the photoelectrodes were evaluated at 1.23 V vs RHE under chopped light to assess the photo-response and charge recombination behaviour of the photoelectrodes (Figure 7b). The photocurrent of the T/BiOI samples is larger than that of bare TiO₂. The photocurrent response of the BiOI layers exhibits a nonlinear increase with a maximum photocurrent of ~40 μ A/cm², which is comparable to the published BiOI/TiO₂ heterojunction photoelectrocatalyst by impregnating–hydroxylation method.²⁸ Under simulated solar irradiation, all samples displayed sharp drops in photocurrent, indicating charge recombination or charge diffusion.³⁷ The light-chopped open circuit voltage transients for T/BiOI photoelectrodes were measured under AM 1.5G illumination, as shown in Figure 7c. Under illumination, the generation of charge carriers resembles a photovoltage. The signal shifting towards lower potentials is attributed to electron injection into the substrates. The open circuit photovoltage (OCP) is the difference between the open circuit voltage (V_{oc}) under illumination and the V_{oc} in dark. An increased OCP is observed when BiOI is deposited on TiO₂, from 0.49 V to 0.65-0.80 V, indicating a higher concentration of surface electrons and better free charge production ability of the BiOI/TiO₂ heterojunctions compared to bare TiO₂.

The semicircular Nyquist plots obtained from electrochemical impedance spectroscopy (EIS) characterization of the photoelectrodes under illumination (Figure 7d) indicate that electron transfer at the electrode/electrolyte interface plays a prominent role in the anodic process. The equivalent circuit in the inset of Figure 7d can be used to analyse the reaction mechanisms involved in the electrode process, where R_s , R_{ct} , and CPE represent the series resistance of the system, the charge transfer resistance, and the chemical capacitance, respectively.^{38,39} The R_{ct} fitting results are shown in Table 2. The larger R_{ct} value of TiO₂ compared to all the T/BiOI samples indicates that the addition of BiOI layers improves the conductivity of the photoanodes. The R_{ct} values of T/BiOI photoanodes initially decrease and then increase as the precursor volume increases. Among these, the T/BiOI 1.2 heterojunction exhibits the lowest R_{ct} value of 10.1 k Ω , indicating the most efficient charge mobility and superior conductivity compared to other T/BiOI photoelectrodes, as expected for the best performing sample.⁴⁰

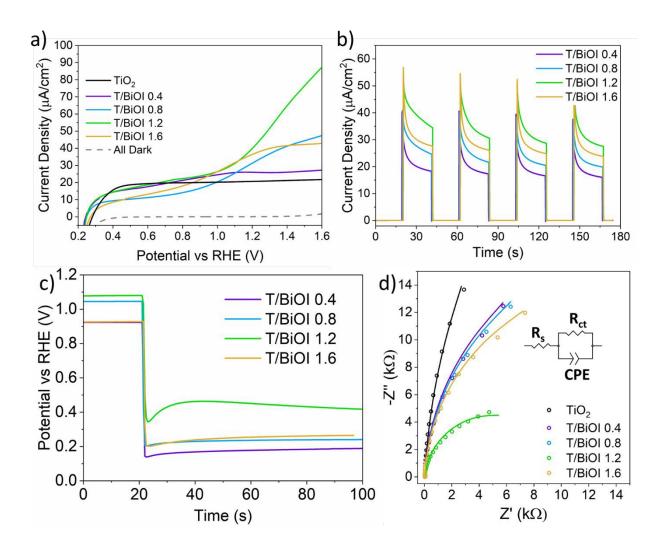


Figure 7. a) LSVs, b) transient photocurrent curves, c) OCP decay profiles, and d) EIS plots and the equivalent circuit for the fitting of the different T/BiOI photoanodes prepared by Autodrop and of bare TiO₂, for the sake of comparison.

Table 2. R_{ct} values of different BiOI/TiO₂ photoanodes obtained from fitting EIS data in Figure 6d.

Sample	R _{ct} (kΩ)
TiO ₂	99.6
T/BiOI 0.4	37.3
T/BiOI 0.8	35.8
T/BiOI 1.2	10.1
T/BiOI 1.6	29.4

The stability of the best BiOI/TiO₂ heterojunction, namely T/BiOI 1.2, was evaluated in a PEC oxidation system through chronoamperometry measurements (Figure 8a). The data reveal that the T/BiOI 1.2 photoelectrode's photocurrent decreases to 12 μ A/cm² after 120 minutes of continuous operation, comparable to the photocurrent of bare TiO₂ (10 μ A/cm²). This reduction in PEC performance may be due to the formation of an insulating hydroxide-based surface layer in aqueous media, as suggested by the work of Hahn N.T et al.⁴¹ To test this hypothesis, XPS analysis was performed on the T/BiOI 1.2 thin film before and after

Open Access Article. Published on 05 September 2024. Downloaded on 9/6/2024 1:59:51 PM

PEC testing (Figure 8b and 8c). The O 1s XPS spectra show an increase in peaks at 531.3 and 532.3 eV, indicating an increase in - OH functionalities on the photoanode surface.

 TiO_2 is a good n-type contact for photoactive heterojunctions, but is also widely used as a protective layer for various semiconductor photoelectrodes due to its high resistance to corrosion and decomposition.³¹ To enhance the PEC activity and stability of the T/BiOI 1.2 photoelectrode, a protective TiO₂ layer was applied using ALD. ALD enables the creation of highly uniform and pinhole-free coatings, essential for effective passivation and protection.⁴² Kargar et al. demonstrated that a 20 nm TiO₂ coating on a 3D ZnO/Si photoelectrode maintained PEC performance for over 24 hours under constant light and bias.⁴³ Inspired by this work, we coated the T/BiOI 1.2 with a 20 nm TiO₂ layer using ALD, creating the T/BiOI 1.2/TiO₂ photoelectrode (lower thicknesses < 20 nm were not successful in ensuring proper photoanode protection). The thickness value of ALD coatings can be easily determined by the number of cycles applied in the deposition set-up.44 Chronoamperometry at 1.23 V vs RHE assesses the photocurrent stability over time (Figure 8a). The ALD-TiO₂ ultra-thin layer significantly improves the photocurrent density, reaching 46 µA/cm² after 2 hours, nearly four times higher than the unprotected T/BiOI photoanode, confirming the necessity of a protective layer which acts as a tunnel barrier for BiOI in PEC applications, to enhance both activity and stability. Al₂O₃ is also frequently used as a protective layer in PEC water oxidation.⁴⁵ To test whether an analogous Al₂O₃ ultra-thin layer could also enhance the PEC activity and stability of T/BiOI 1.2, a 20 nm Al₂O₃ protective coating was applied on T/BiOI 1.2 using ALD. Chronoamperometry results for T/BiOI 1.2/Al₂O₃ (Figure S7) show an initial photocurrent increase to approximately 70 μ A/cm², followed by a drop to less than 20 μ A/cm² after 60 minutes and further to 11 μ A/cm² after 120 minutes. Ultimately, the Al₂O₃ ultra-thin layer does not improve the performance compared to ultra-thin TiO₂, suggesting that TiO₂ endows better chemical and mechanical resistance to solution-processed nanostructured BiOI in the here employed aqueous electrolyte.⁴⁶

Finally, the incident photon to current efficiency (IPCE) spectra for the T/BiOI 1.2 and T/BiOI 1.2/TiO₂ photoanodes were measured at 1.23 V vs RHE. Both T/BiOI 1.2 and T/BiOI 1.2/TiO₂ showed a sharp increase in IPCE values for wavelengths below 420 nm, indicating efficient photocurrent generation from higher energy photons (Figure S8). Pure TiO₂ performed poorly around 370 nm, but the junction with BiOI significantly increased the IPCE, highlighting enhanced charge separation. But pure TiO₂ shows a higher IPCE at around 350 nm, which shows that the pure TiO₂ has higher conversion efficiency under UV light, as TiO₂ is a well-known photocatalyst under UV light.⁴⁷ Furthermore, the photoelectric conversion efficiency of T/BiOI 1.2/TiO₂ was approximately twice that of T/BiOI 1.2, demonstrating that the TiO₂ protection layer effectively inhibits rapid charge recombination, enhancing performance in PEC water oxidation.

Energy Advances Accepted Manuscrip

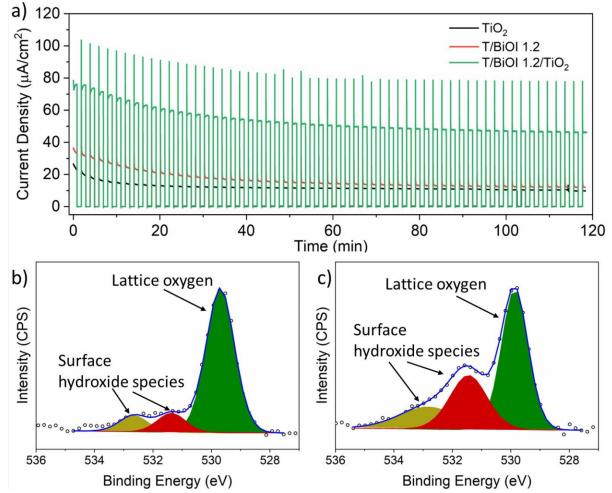


Figure 8. a) Chronoamperometry at 1.23 V vs RHE of the T/BiOI 1.2 film with and without a 20 nm ALD-TiO₂ layer compared with a bare mesoporous TiO₂ photoanode. High resolution XPS spectra of O 1s on T/BiOI 1.2 b) before and c) after the chronoamperometry measurement.

3. Conclusions

In summary, BiOI/TiO₂ photoanodes were fabricated using an automated process derived from the SILAR method, integrating continuous delivery of two liquid solutions with spin-coating, which is here presented for the first time and named Autodrop. This approach enables the sustainable fabrication of thin films using aqueous-based inks at room temperature. Utilizing a syringe pump on a spin-coating platform, the Autodrop method offers precise control over the thickness and band gap of BiOI thin films grown on mesoporous TiO₂ substrates by adjusting precursor volumes. This method enhances film homogeneity and production efficiency compared to manual techniques, underscoring its potential for scaling up solution-based processing of functional inorganic semiconductors.

The Autodrop-produced BiOI/TiO₂ heterojunctions were evaluated for their activity in OER, identifying an optimized photoanode produced with 1.2 mL of each precursor solution. To enhance stability, a protective ultra-thin TiO₂ layer deposited via ALD was applied, resulting in improved photocurrent and durability of the photoanode during prolonged operation. This study provides

This article is licensed under a Creative Commons Attribution-NonCommercial 3.0 Unported Licence

Open Access Article. Published on 05 September 2024. Downloaded on 9/6/2024 1:59:51 PM

8

valuable insights into automating SILAR-based thin films production, which holds great promise for future large-scale manufacturing of sustainable semiconductor-based photoelectrodes.

4. Experimental Section

Materials. Bismuth(III) nitrate pentahydrate (Bi(NO₃)₃·5H₂O) and potassium iodide (KI) were purchased from Thermo Fisher Scientific, the mesoporous titania precursor (Ti-Nanoxide T600/SC and Ti-Nanoxide BL/SC) was purchased from Solaronix and the FTO coated glass substrates were purchased from Sigma-Aldrich.

*Preparation of mesoporous TiO*² *thin films.* FTO-coated glass substrates were chosen as the supporting material. Initially, they underwent a thorough cleaning process in an ultrasonic bath, where they were sequentially immersed in deionized water and then in a 1:1 mixture of acetone and isopropanol, each cycle lasting 15 minutes. Subsequently, the substrates were dried using compressed air and further treated with a UV-ozone cleaner (Ossila) for 15 minutes immediately prior to use. To fabricate mesoporous TiO₂ films, a specific amount of Ti nanoxide T600/SC (Solaronix) was deposited onto the cleaned FTO glass substrate (30 μL per 1 cm²). The substrate was then rotated at 84 revolutions per second (rps) for 30 seconds. Following this, the substrate underwent calcination at 475 °C in an oven for 30 minutes, resulting in the formation of a mesoporous TiO₂ film with an approximate thickness of 600 nm. Meanwhile, pure FTO glass substrates and FTO glasses with planar TiO₂ were prepared as reference substrates for the subsequent deposition of BiOI. The deposition procedure for the planar blocking layer films mirrored that for mesoporous TiO₂, except for the calcination step, where the films were heated at 550 °C for one hour.

Synthesis of BiOI thin films. The precursor solutions used were 5 mM KI and 5 mM Bi(NO₃)₃·5H₂O in aqueous form. It is crucial to freshly prepare the Bi(NO₃)₃ solution immediately before use because Bi(NO₃)₃ can undergo hydrolysis over time, forming insoluble basic salts like BiONO₃, Bi₂O₂(OH)NO₃, and Bi₆O₄(OH)₄(NO₃)₆·H₂O, which can affect the stoichiometry of the Bi precursor.⁴⁸ The two solutions were simultaneously dispensed using a Harvard Apparatus-11 Plus 70-2212 Syringe Pump at a constant rate of 75 µL/min onto the substrate, which was continuously spinning at 30 rps on a KLM Spin-Coater SCV-10. After deposition, the substrates underwent a heating step at 100 °C for 1 hour to remove residual water. A schematic illustrating the preparation of BiOI layers on TiO₂ thin films using the AutoDrop method is presented in Figure 1. For comparison, a standard spin-SILAR method was used to prepare BiOI thin films by manually dropping 50 µL of each precursor solution, spinning for 20 seconds at 30 rps, and repeating this process for 45 cycles.

Deposition of protection layers by ALD. The TiO₂ protection layer was deposited using a PicoSun R200 ALD at a reaction temperature of 150 °C. Each cycle involved TiCl₄ as the precursor (flow rate 100 sccm, pulse time 0.1 s, purge time 5 s), followed by water as the oxygen source (flow rate 150 sccm, pulse time 3 s, purge time 5 s). The growth rate was 0.06 nm per cycle, and a total of 333 cycles were performed to achieve a 20 nm thick TiO₂ layer. Similarly, the Al₂O₃ protection layer was grown at the same reaction temperature of 150 °C. Each cycle utilized trimethylaluminum as the precursor (flow rate 100 sccm, pulse time 0.1 s, purge time 3 s), followed by water as the oxygen source (flow rate 150 sccm, pulse time 1 s, purge time 3 s). The growth rate was 0.106 nm per cycle, and 189 cycles were carried out to achieve a 20 nm thick Al₂O₃ layer.

Characterization. SEM images were acquired using a Carl Zeiss GeminiSEM 560 field emission scanning electron microscope equipped with an InLens SE Detector. Imaging was conducted at an acceleration voltage of 3.00 kV, with a working distance of 3 mm, and a beam current of 100 pA. GIXRD measurements were performed on a PANalytical X'Pert PRO MRD instrument using Cu K α radiation (λ = 1.5406 Å). The instrument operated at a current of 40 mA and an acceleration voltage of 40 kV. Optical absorption properties were characterized using a UV-vis-NIR Spectrometer (Agilent Cary 5000) with a scan resolution of 1 nm.

Thin film absorption and transmission spectra were acquired using an integrating sphere (Diffuse Reflectance Accessory 150mm, DRA-2500) attached to the spectrophotometer. Baseline acquisition was conducted with the empty integrating sphere. XPS analysis was carried out on a PHI 5000 VersaProbe II Scanning ESCA Microprobe (Physical Electronics) equipped with a monochromatized Al K α X-ray source operating in high power mode (beam size 1300 μ m × 100 μ m, X-ray power: 100 W). Spectra were acquired with time steps of 50 ms, a step size of 0.2 eV, and an analyzer pass energy of 46.95 eV. Each detailed region averaged over 30 sweeps or a P/N ratio of 180. The sample surface was neutralized using slow electrons and argon ions, and the measurement was conducted under vacuum conditions ranging from 10–7 Pa to 10–6 Pa. Data analysis was performed using CasaXPS software. KPFM measurements were conducted with an AIST NT Vacuscope 1000 microscope operated below 5 · 10–6 mbar, using SPARK 350 Pt-coated AFM probes excited at around 300 kHz resonance frequency. The work function was determined by measuring the contact potential difference between the probe and sample via FM-KPFM, with an AC amplitude of 2 V at approximately 1 kHz. The probe work function was referenced against freshly cleaved highly oriented pyrolytic graphite (ZYB, MikroMasch) with a known work function of 4.6 eV, before and after each measurement.

Photoelectrochemical characterization. For the PEC measurements, a SP-300 potentiostat/galvanostat from BioLogic, controlled by EC-Lab software, was utilized. The setup employed a three-electrode configuration comprising a platinum wire counter electrode, an Ag/AgCl (saturated KCl) reference electrode, and a working electrode. Potentials recorded against Ag/AgCl were converted to the RHE scale using the equation:

E (V vs RHE) = E (V vs Ag/AgCl) + 0.197 V + 0.059 V x pH

The working electrode consisted of an FTO-coated glass substrate, with half of it masked by an adhesive strip to form the multilayer photoelectrode only on one side. The masked part with bare FTO was connected to a platinum plate electrode holder. The samples were illuminated from the front through a quartz window on the PEC cell with simulated solar light generated by an LS0106 Xenon arc lamp equipped with an LS2189 AM 1.5G filter, adjusted to an intensity of 100 mW cm⁻². EIS was conducted at 1.23 V vs RHE under simulated solar light with the amplitude of 10 mV, sweeping frequencies from 100 kHz to 2 Hz.

IPCE was calculated using an LSB5511000 W xenon short arc lamp from LOT-Oriel, coupled to an Acton SpectraPro 2300i monochromator. This measurement was performed concurrently with chronoamperometry under conditions identical to the PEC measurements. The IPCE at a specific wavelength (λ) was determined using the formula:

$$IPCE(\lambda) = \frac{J(\lambda)}{e \times N_{Ph}(\lambda)} \times 100\%$$

where J(λ) is the photocurrent density (mA/cm²) at a specific wavelenght (λ) and N_{ph}(λ) is number of photons at a specific wavelength. N_{ph}(λ) was obtained using an FDS100 silicon photodiode from Thorlabs through the formula:

$$N_{Ph}(\lambda) = \frac{J_{Pd}(\lambda) \times \lambda}{h \times c \times R_{Pd}(\lambda)}$$

where $J_{Pd}(\lambda)$ is the photocurrent density measured with the photodiode and R $_{Pd}(\lambda)$ is the photodiode responsivity.

Acknowledgements

T.G. acknowledges the support of the European Research Council for the project JANUS BI (grant agreement no. [101041229]). M.W. and T.G. also thank Fondazione Compagnia di San Paolo for financial support through the "Bando TRAPEZIO - Paving the way to research excellence and talent attraction". T.G. is also further grateful to Compagnia di San Paolo for the support through

Open Access Article. Published on 05 September 2024. Downloaded on 9/6/2024 1:59:51 PM

the Starting Grant ERC program. R.A., B.S. and T.G. would like to thank the DFG for project 460609161. F.B., M.C., I.K., B.S. and

T.G. thank the European Commission for the project LIGHT CAP (grant agreement no. [101017821]).

References

1

2

4

- J. Joy, J. Mathew and S. C. George, Int. J. Hydrogen Energy, 2018, 43, 4804–4817.
- I. Roger, M. A. Shipman and M. D. Symes, Nat. Rev. Chem., 2017, 1, 1–13.
- 3 M. Wang, M. Langer, R. Altieri, M. Crisci, S. Osella and T. Gatti, ACS Nano, 2024, 18, 9245–9284.
 - W. Yang, R. R. Prabhakar, J. Tan, S. D. Tilley and J. Moon, *Chem. Soc. Rev.*, 2019, **48**, 4979–5015.
- 5 B. Moss, O. Babacan, A. Kafizas and A. Hankin, Adv. Energy Mater., 2021, 11, 2003286.
- W. Li, X. Wang, Y. Zhang, S. Zhu, M. Zhao, H. Zhang, Y. Wang, D. Zhang, W. Ran, L. Zhang, N. Li, T. Yan, W. Li, X. Wang, Y. Zhang, S. Zhu, M. Zhao, H. Zhang, Y. Wang, D. Zhang, W. Ran, L. Zhang, N. Li and T. Yan, *Adv. Mater. Interfaces*, 2022, 9, 2200260.
- 7 F. Schmitz, R. Bhatia, F. Lamberti, S. Meloni and T. Gatti, APL Energy, , DOI:10.1063/5.0161023.
- 8 A. A. Abuelwafa, R. M. Matiur, A. A. Putri and T. Soga, Opt. Mater. (Amst)., 2020, 109, 110413.
- 9 N. T. Hahn, S. Hoang, J. L. Self and C. B. Mullins, ACS Nano, 2012, 6, 7712–7722.
- 10 X. Li, J. Xia, W. Zhu, J. Di, B. Wang, S. Yin, Z. Chen and H. Li, *Colloids Surfaces A Physicochem. Eng. Asp.*, 2016, **511**, 1–7.
- 11 Y. Bai, H. Bai, K. Qu, F. Wang, P. Guan, D. Xu, W. Fan and W. Shi, Chem. Eng. J., 2019, 362, 349–356.
- 12 B. Long, X. Liang, Y. Pei, X. Wu, X. Wang and M. K. Law, J. Mater. Sci. Technol., 2024, 198, 137–142.
- 13 Y. Xin, Z. Wang, H. Yao, W. Liu, Y. Miao, Z. Zhang and D. Wu, Sensors Actuators B Chem., 2023, 393, 134285.
- 14 I. N. Reddy, B. Akkinepally, C. Bai and J. Shim, *Crystals*, 2022, **12**, 1727.
- 15 J. Qiao, Y. Wang, S. Dong, Q. Liang and S. Shao, ACS Appl. Nano Mater., 2023, 6, 5664–5674.
- 16 M. Wang, A. Kafizas, S. Sathasivam, M. O. Blunt, B. Moss, S. Gonzalez-Carrero and C. J. Carmalt, *Appl. Catal. B Environ.*, 2023, **331**, 122657.
- 17 S. P. Ratnayake, J. Ren, E. Colusso, M. Guglielmi, A. Martucci, E. Della Gaspera, S. P. Ratnayake, J. Ren, E. Della Gaspera, E. Colusso, M. Guglielmi and A. Martucci, *Small*, 2021, **17**, 2101666.
- 18 J. Ho Kim, G. Yang Kim, S. Ho Sohn -, P. Kumar, G. K. Rao, A. D. C -, M. Akimoto, Q. Shen, J. Joo, D. Kim, D.-J. Yun, H. Jun, S.-W. Rhee, J. Sung Lee, K. Yong, S. Kim and S. Jeon, *Nanotechnology*, 2010, **21**, 325604.
- 19 A. A. Putri, A. A. Abuelwafa, S. Kato, N. Kishi and T. Soga, SN Appl. Sci., 2020, 2, 1–8.
- 20 H. Wang, Y. Liang, L. Liu, J. Hu, P. Wu and W. Cui, Appl. Catal. B Environ., 2017, 208, 22–34.
- 21 J. Di, J. Xia, M. Ji, L. Xu, S. Yin, Z. Chen and H. Li, J. Mater. Chem. A, 2016, 4, 5051–5061.
- 22 B. Ogoh-Orch, P. Keating and A. Ivaturi, ACS Omega, 2023, 8, 43556–43572.
- 23 G. Pan, J. Li, G. Zhang, Y. Zhan and Y. Liu, J. Alloys Compd., 2023, 938, 168469.
- 24 X. Liao, T. T. Li, H. T. Ren, X. Zhang, B. Shen, J. H. Lin and C. W. Lou, Sci. Total Environ., 2022, 806, 150698.
- 25 X. Zhang, L. Zhang, T. Xie and D. Wang, J. Phys. Chem. C, 2009, **113**, 7371–7378.
- 26 J. Liu, L. Ruan, S. B. Adeloju and Y. Wu, *Dalt. Trans.*, 2013, **43**, 1706–1715.
- H. Chen, Y. P. Peng, T. Y. Chen, K. F. Chen, K. L. Chang, Z. Dang, G. N. Lu and H. He, Sci. Total Environ., 2018, 633, 1198–1205.
- 28 G. Dai, J. Yu and G. Liu, J. Phys. Chem. C, 2011, 115, 7339–7346.
- 29 J. Shi, X. Zhao and C. Li, *Catal. 2023, Vol. 13, Page 217*, 2023, **13**, 217.
- 30 T. Moehl, J. Suh, L. Sévery, R. Wick-Joliat and S. D. Tilley, ACS Appl. Mater. Interfaces, 2017, 9, 43614–43622.
- 31 A. Kargar, K. Sun, Y. Jing, C. Choi, H. Jeong, G. Y. Jung, S. Jin and D. Wang, ACS Nano, 2013, 7, 9407–9415.
- 32 M. J. Choi, J. Y. Jung, M. J. Park, J. W. Song, J. H. Lee and J. H. Bang, J. Mater. Chem. A, 2014, 2, 2928–2933.
- 33 R. Liu, Z. Zheng, J. Spurgeon and X. Yang, *Energy Environ. Sci.*, 2014, **7**, 2504–2517.
- Y. Gao, J. Zhang, Y. Su, H. Wang, X. X. Wang, L. P. Huang, M. Yu, S. Ramakrishna and Y. Z. Long, *Mater. Horizons*, 2021, 8, 426–446.
- 35 X. Zhang and L. Zhang, J. Phys. Chem. C, 2010, 114, 18198–18206.
- A. Crovetto, A. Hajijafarassar, O. Hansen, B. Seger, I. Chorkendorff and P. C. K. Vesborg, *Chem. Mater.*, 2020, 32, 3385–3395.
- 37 L. Li, P. dong Wu, W. Li, J. Huang, H. Li and S. Yang, Small Struct., 2024, 2300531.
- 38 X. Zhang, H. Yang, B. Zhang, Y. Shen and M. Wang, *Adv. Mater. Interfaces*, 2016, **3**, 1500273.
- L. Yang, R. Wang, N. Zhou, L. Jiang, H. Liu, Q. He, C. Deng, D. Chu, M. Zhang and Z. Sun, *Appl. Surf. Sci.*, 2022, 601, 154277.

- 40 T. Wang, L. Guo, H. Pei, S. Chen, R. Li, J. Zhang, T. Peng, T. X. Wang, L. L. Guo, H. Pei, S. T. Chen, R. J. Li, J. Zhang and T. Y. Peng, *Small*, 2021, **17**, 2102957.
- 41 N. T. Hahn, S. Hoang, J. L. Self and C. B. Mullins, ACS Nano, 2012, 6, 7712–7722.
- 42 J. Zhang, Y. Li, K. Cao and R. Chen, *Nanomanufacturing Metrol. 2022 53*, 2022, **5**, 191–208.
- 43 A. Kargar, K. Sun, Y. Jing, C. Choi, H. Jeong, Y. Zhou, K. Madsen, P. Naughton, S. Jin, G. Y. Jung and D. Wang, *Nano Lett.*, 2013, **13**, 3017–3022.
- 44 M. Ylilammi, *Thin Solid Films*, 1996, **279**, 124–130.
- 45 C. Liu, C. Zhang, G. Yin, T. Zhang, W. Wang, G. Ou, H. Jin and Z. Chen, ACS Appl. Mater. Interfaces, 2021, **13**, 13301– 13310.
- 46 V. Dias, H. Maciel, M. Fraga, A. O. Lobo, R. Pessoa and F. R. Marciano, Materials (Basel)., 2019, 12, 682.
- 47 M. Wang, F. Zhang, X. Zhu, Z. Qi, B. Hong, J. Ding, J. Bao, S. Sun and C. Gao, *Langmuir*, 2015, **31**, 1730–1736.
- 48 G. Gattow and D. Schott, Zeitschrift für Anorg. und Allg. Chemie, 1963, **324**, 31–47.

Page 17 of 17

The data supporting this article have been included as part of the Supplementary Information Article Online DOI: 10.1039/D4YA00405A

Energy Advances Accepted Manuscript